

Product End-of-Life Disassembly Instructions
Product Category: **Storage**
Marketing Name / Model
[List multiple models if applicable.]

HPE Apollo 4200 Gen10 Plus System

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HPE products to remove components and materials requiring selective treatment, as defined by Directive 2012/19/EU of the European Parliament and of the Council on Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

Item Description	Notes	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq cm	15
Batteries	All types including standard alkaline and lithium coin or button style batteries	2
Mercury-containing components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries	0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps	0
Cathode Ray Tubes (CRT)		0
Capacitors / condensers (Containing PCB/PCT)		0
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height		4
External electrical cables and cords		0
Gas Discharge Lamps		0
Plastics containing Brominated Flame Retardants weighing > 25 grams (not including PCBs or PCAs already listed as a separate item above)		0

Item Description	Notes	Quantity of items included in product
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations.	0
Components and waste containing asbestos		0
Components, parts and materials containing refractory ceramic fibers		0
Components, parts and materials containing radioactive substances		0

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description	Tool Size (if applicable)
Torx driver	T10, T15
Phillips screwdriver	#2
Flathead screwdriver	Medium
Socket screwdriver	5 mm / 8 mm

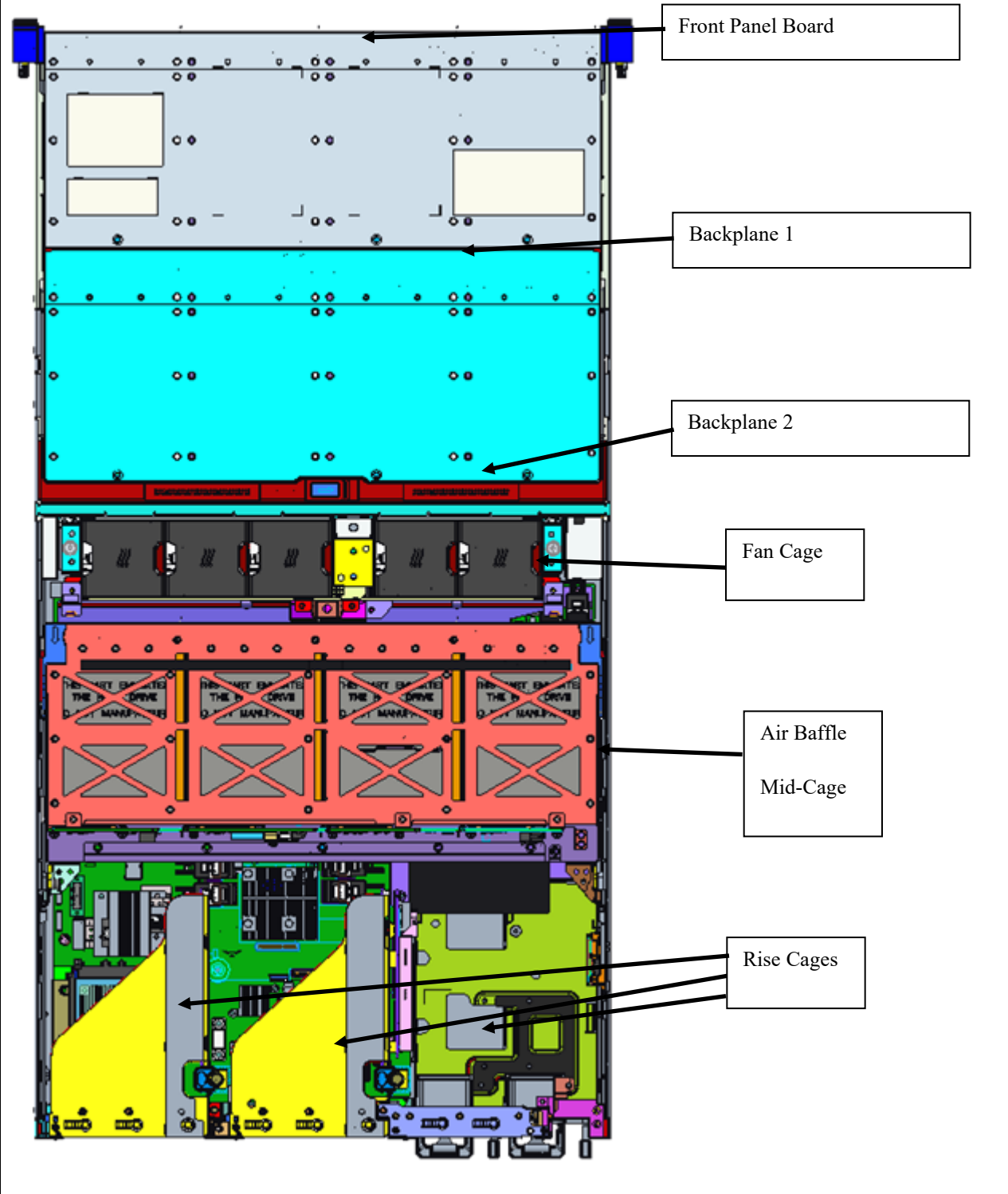
3.0 Product Disassembly Process

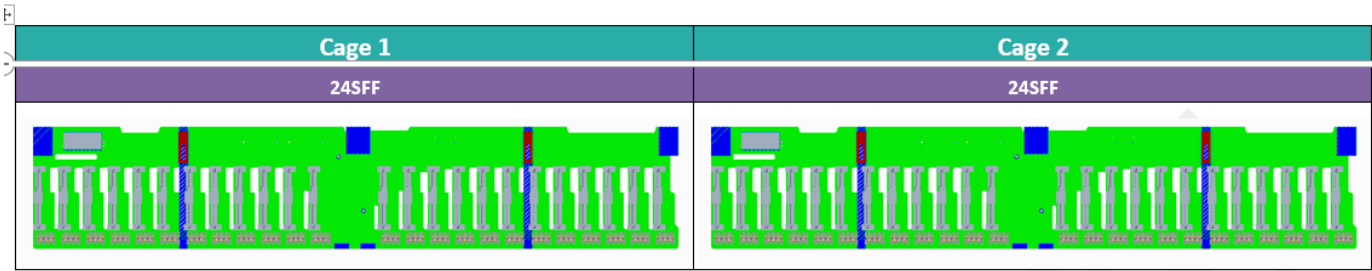
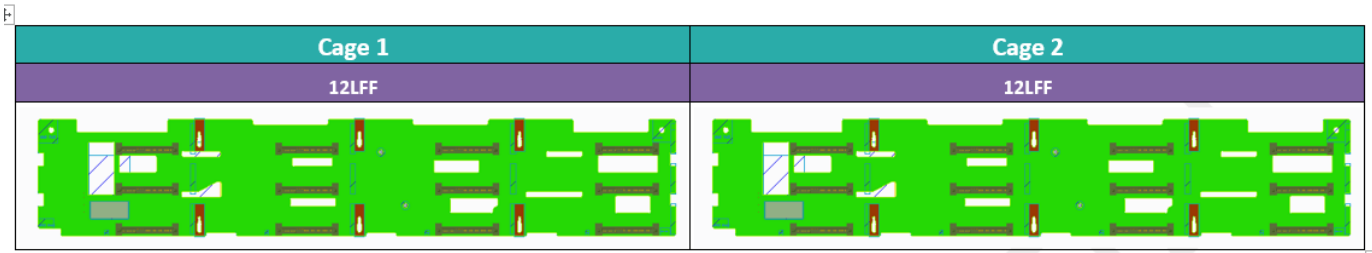
3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. System Battery - Remove the top cover and locate the standup card in back pci card slot bay next to the chassis wall. Remove the board by pulling the front CPU drawer out ~ 3 inches then unscrewing the PCA's two blue finger screws located on both ends of the PCA. Use a medium flat head screwdriver or fingers to remove the battery and dispose of properly.
2. Megacell - Some models, remove the battery from the holder and disconnect cable from PCA.
3. Capacitors=>2.5CM - Remove the power supplies from the system. With a #2 Philips screw driver, remove the screws securing the top cover, then locate the capacitors and pry from the PCB with a medium flat head screw driver and dispose of properly.

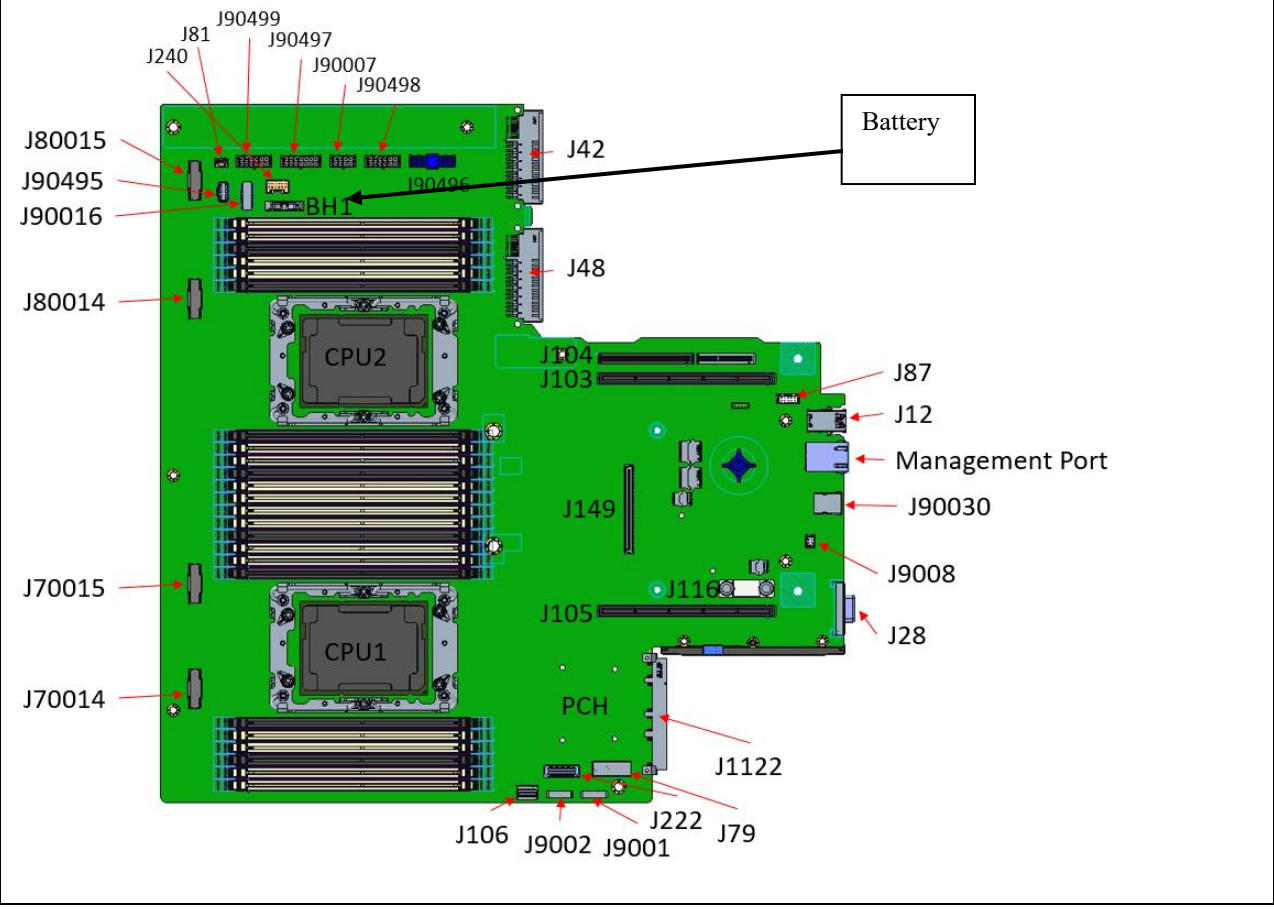
3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

2. Remove Fan cage module, Air baffle, Mid-Cage and Riser cage from system.





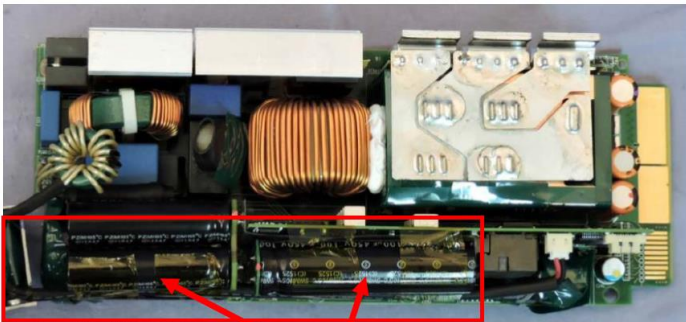
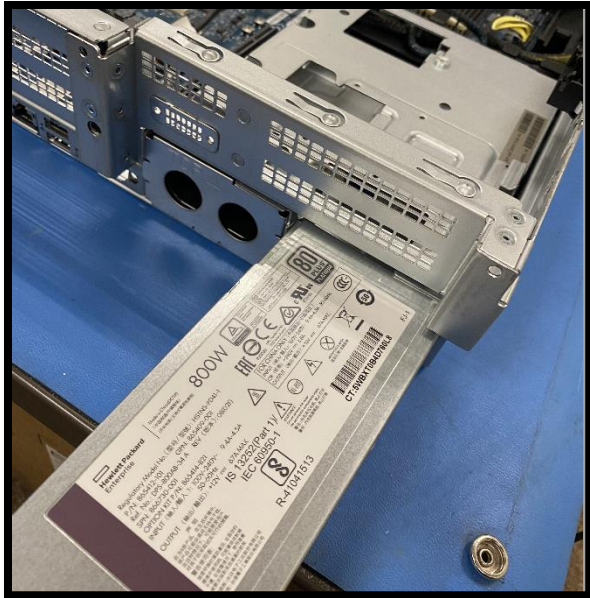
3. Remove lithium battery from the system by medium flat head screw driver.



Remove Megacell



6. Remove the power supply(s) from system.



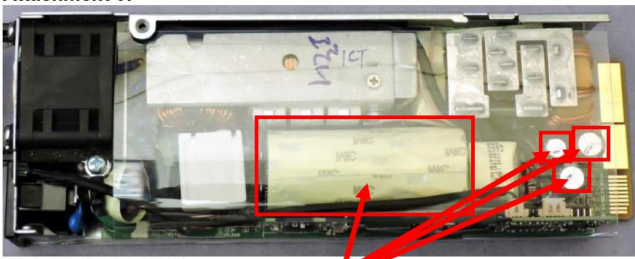
Model: HSTNS-PL62

Remove Capacitors



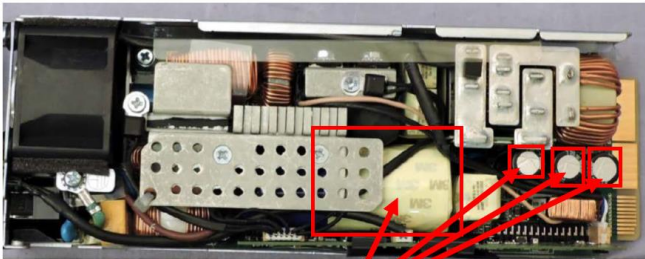
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Remove Capacitors



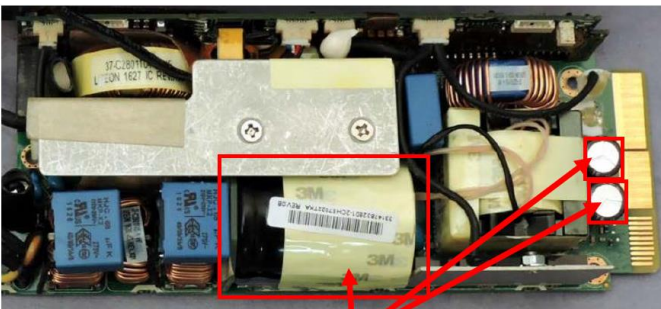
Model: HSTNS-PC41

Remove Capacitors



Model: HSTNS-PL41

Remove Capacitors



Remove Capacitors